ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	© Co	terial Compo pyright 2005. IPC, Bannocl International and Pan-Americ	kburn, Illinois.	. All rights reserv	tion with lower	level p	arts, the	declaratio	n encon	npasses a	all lower	level mater	rials for	which t	e item is an assembly he manufacturer has declaration.	
1752-2 1.1		Web Site for Informat		-1752 Standa	rd	Form Type * Distribute			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Inform							
Supplier Information																
Company Name *		Company Unique ID		Unique ID Au	Response Date *			Response Docume			nent ID					
SEMTECH CORPORATION 00-847-9941				DUNS		2016-0	8-02									
Contact Name * ROYA MOTAMEDI	Title - Contact Supervisor, QA Prod		Phone - Con 805-498-211	Email - Contact * rmotamedi@semtech.co			om	Duplicate Contact -> Authorized Representative								
Authorized Representati ROYA MOTAMEDI	Title - Representative Supervisor, QA Prod		Phone - Rep 805-498-211	Email - Representative * rmotamedi@semtech.com				Supplier	Commer	nts or URL	for Add	litional I	nformation			
Requester Item Number		Mfr Item Number		Mfr Item Name	Effective Date Versio			on Manufacturin		ng Site Weight		UC	M	Unit Type		
	SC4211HSTRT			Very Low Input / Very Low Drop					Philippines		78		mg)	Each	
Alternate Recommenda	Alternate Recommendation				Alternate			Item Co	em Comments							
Manufacturing Proces	ss In	formation														
Terminal Plating / Grid Array	Materi	al	Terminal Ba	ase Alloy	J-STD-020 MSL Ra	iting	Peak Proc	ess Body	Temper	ature Max	x Time at	Peak Temp	erature	Number	of Reflow Cycles	
Matte Tin (Sn) CU Alloy			1			260			c		30 se	30 seconds 3				
Comments SC4211HSTRT is a REA	CH-co	ompliant product, pe	er EU Reg	ulation EC19	07/2006 to includ	e recei	nt additio	on of SVI	HC can	didate lis	st of sul	bstances i	in June	2016.		

Save the fields in this form to a file	Export Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent chan	Look Cumption Fields						
RoHS Material	RoHS Material Composition Declaration Declaration Type * Detailed												
		limit of 0.1% by mass (100 thers (PBDE) and quantity	, .				ominated Biphenyls (PBB),						
chromium, polybrominate excess of an applicable of gathered the information Company will rely on this completing this form, and certifications regarding the conditions of that agreen	ed biphenyls and/or polybrominated quantity limit, please indicate below it provides in this form using approp certification in determining the com I that Supplier may not have independent rein contributions to the part, and the nent, including any warranty rights a	which, if any, RoHS exemption you b priate methods to ensure its accuracy apliance of its products with European andently verified such information. Ho pose certifications are at least as comp	icted substance") in excess believe may apply. If the p y and that such information n Union member state laws bowever, in situations where prehensive as the certification that agreement, will be the s	of the applicable quantity limit bart is an assembly with lower I is true and correct to the best of that implement the RoHS Dire Supplier has not independentl on in this paragraph. If the Co ole and exclusive source of the	identified above. If a homogene- evel components, the declaration of its knowledge and belief, as of ctive. Company acknowledges to y verified information provided by mpany and the Supplier enter into a Supplier's liability and the Comp	eous material within the part cont n shall encompass all such comp f the date that Supplier complete that Supplier may have relied on y others, Supplier agrees that, at to a written agreement with response upany's remedies for issues that a	tains a RoHS restricted substance in ponents. Supplier certifies that it s this form. Supplier acknowledges that						
RoHS Declaration	n * 1 - Item(s) does not contain	RoHS restricted substances per th	he definition above			Supplier Acceptance *	Accepted						
	declared item does not cont Il applicable exemptions.	ain RoHS restricted substanc	es per the definition a	bove except for defined	RoHS exemptions, then s	select the corresponding re	esponse in the RoHS Declaration						
Declaration Si	gnature												
		C 1 1 11 C (1 1)			· • • • • •	T 1: 10 11 1 4	D' i ll i						

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem		Homogeneous	Weight	Unit of			Level	Substance Category			Substance	CAS	Exempt	Weight		Tolerance		PPM
	Name		Material	weight	Measure			Levei	Substance Category			Substance	CAS	Exempt	weight	Measure	-	+	
+ -	SILICON CHIP	+M -M	Silicon Die	2.7	mg	+C	-C s	Supplier		+S	-S	Silicon (Si)	7440-21-3		2.7	mg			34,397
+I -I	LEAD FRAME, SOIC	+M -M	CDA194	24.89	mg	+C ·	-C s	Supplier		+S	-S	Copper (Cu)	7440-50-8		24.1433	mg			307,57
										+S	-s	Iron (Fe)	7439-89-6		0.5849	mg			7,451.6
										+S	-s	Zinc (Zn)	7440-66-6		0.0299	mg			380.50
						_				+S	-s	Phosphorous (P)	7723-14-0		0.0199	mg			253.67
		+M -M	Silver spot platir	0.112	mg	+C	-C s	Supplier		+S	-S	Silver (Ag)	7440-22-4		0.112	mg			1,426.9
+ -	DIE ATTACH MATE	+M -M	2600AT	1.73	mg	+C ·	-C s	Supplier		+S	-S	Silver (Ag)	7440-22-4		1.25	mg			15,978
		_								+S	-s	Epoxy Resin	Proprietary		0.35	mg			4,407.9
										+S	-s	n-paraffinic HydroCarbo	Proprietary		0.13	mg			1,652.9
+I -I	WIRE BONDING	+M -M	Gold Wire	0.265	mg	+C	-C s	Supplier		+S	-S	Gold (Au)	7440-57-5		0.265	mg			3,375.6
+I -I		+M -M	EME-G600	48	mg	+C	-C s	Supplier		+S	-S	Silica Fused	606076-86-0		42	mg			534,06
										+S	-s	Epoxy Resin	Proprietary		2.4	mg			30,517
										+S	-s	Epoxy, Cresol Novolac	29690-82-2		0.958	mg			12,207
										+S	-s	Phenol Resin	Proprietary		2.4	mg			30,517
										+S	-s	Carbon Black	1333-86-4		0.24	mg			3,051.7
+I -I	PLATING - TIN	+M -M	Tin (Sn)	1	mg	+C	-C s	Supplier		+S	-s	Tin (Sn)	7440-31-5		1	mg			12,733
						+C ·	-C 🏼	4	Lead/Lead Compound	+S	-s	Lead	7439-92-1		0.0005	mg			6.6246